

In the specification:

[0004] To solve this problem, a type of a film transfer device has been available which transfers a transfer tape including an arbitrary film to a film-transferred surface. Various shapes and structures have been proposed for this type (for example, Japanese Patent Laid-Open No. 2000-59692, 2002-59692 Japanese Patent Laid-Open No. 10-119489, Japanese Design Publication No. 1059863, Japanese Design Publication No. 1085305, and Japanese Design Publication No. 1089536).